## FEATURES:

- Enhanced $N$ channel FET with no inherent diode to Vcc
- $5 \Omega$ bidirectional switches connect inputs to outputs
- Pin compatible with the 74F253, 74FCT253, and 74FCT253T
- Zero propagation delay, zero ground bounce
- Undershoot clamp diodes on all switch and control inputs
- TTL-compatible control inputs
- $25 \Omega$ resistors for low noise
- Available in QSOP and SOIC Packages


## APPLICATIONS

- Logic replacement
- Video, audio, graphics switching, muxing
- Hot-swapping, hot-docking
- Voltage translation (5V to 3.3V)
- Power conservation
- Bus funneling


## DESCRIPTION:

The QS32253 is a high-speed CMOS TTL-compatible dual 4:1 multiplexer/demultiplexer with 3-state outputs. The QS32253 is function and pinout compatible version of the 74F253, 74FCT253, and the 74ALS/AS/ LS253 dual 4:1 multiplexers. The QS32253 has $25 \Omega$ resistors to reduce ground bounce noise.

Mux/Demux devices provide an order of magnitude faster speed than equivalent logic devices.

The QS32253 is characterized for operation at $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.

FUNCTIONAL BLOCK DIAGRAM


## PIN CONFIGURATION



SOIC/ QSOP TOP VIEW

## ABSOLUTE MAXIMUM RATINGS ${ }^{(1)}$

| Symbol | Description | Max. | Unit |
| :---: | :---: | :---: | :---: |
| Vterm ${ }^{(2)}$ | Supply Voltage to Ground | -0.5 to +7 | V |
| Vterm ${ }^{(3)}$ | DC Switch Voltage Vs | -0.5 to +7 | V |
| Vterm ${ }^{(3)}$ | DC Input Voltage Vin | -0.5 to +7 | V |
| VAC | AC Input Voltage (pulse width $\leq 20 \mathrm{~ns}$ ) | -3 | V |
| Iout | DC Output Current | 120 | mA |
| Pmax | Maximum Power Dissipation ( $\mathrm{TA}_{\mathrm{A}}=85^{\circ} \mathrm{C}$ ) | 0.5 | W |
| TstG | Storage Temperature | -65 to +150 | ${ }^{\circ} \mathrm{C}$ |

## NOTES:

1. Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
2. Vcc Terminals.
3. All terminals except Vcc.

## CAPACITANCE

( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{f}=1.0 \mathrm{MHz}, \mathrm{VIN}=0 \mathrm{~V}$, VOUT $=0 \mathrm{~V}$ )

| Pins |  | Typ. | Max. ${ }^{(1)}$ | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Control Pins |  | 4 | 5 | pF |
| Quickswitch Channels <br> (Switch OFF) | Demux | 5 | 7 | pF |
|  | Mux | 14 | 16 | pF |

NOTE:

1. This parameter is guaranteed but not production tested.

## PIN DESCRIPTION

| Pin Names | I/O | Description |
| :---: | :---: | :--- |
| Ixx | I | Data Inputs |
| $\mathrm{S} 0, \mathrm{~S} 1$ | I | Select Inputs |
| $\overline{\mathrm{EA}}, \overline{\mathrm{EB}}$ | I | Enable Inputs |
| $\mathrm{Y}_{\mathrm{A}}, \mathrm{Y}_{\mathrm{B}}$ | 0 | Data Outputs |

FUNCTION TABLE(1)

| Enable |  | Select |  | Outputs |  | Function |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\overline{E A}$ | $\overline{E B}$ | S1 | So | $Y_{A}$ | YB |  |
| H | X | X | X | Hi-Z | X | Disconnected |
| X | H | X | X | X | $\mathrm{Hi}-\mathrm{Z}$ | Disconnected |
| L | L | L | L | IOA | lob | $\mathrm{S}_{1}-0=0$ |
| L | L | L | H | 114 | 118 | S $1-0=1$ |
| L | L | H | L | 12 A | 12 B | S $1-0=2$ |
| L | L | H | H | ІзА | I3B | S $1-0=3$ |

## NOTE:

1. $\mathrm{H}=\mathrm{HIGH}$ Voltage Level

L = LOW Voltage Level
X = Don't Care
Z = High-Impedence

## DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified:
Industrial: $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}, \mathrm{Vcc}=5.0 \mathrm{~V} \pm 5 \%$

| Symbol | Parameter | Test Conditions | Min. | Typ. ${ }^{(1)}$ | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| VIH | Input HIGH Voltage | Guaranteed Logic HIGH for Control Pins | 2 | - | - | V |
| VIL | Input LOW Voltage | Guaranteed Logic LOW for Control Pins | - | - | 0.8 | V |
| lin | Input Leakage Current (Control Inputs) ${ }^{(2)}$ | $\mathrm{OV} \leq \mathrm{VIN} \leq \mathrm{Vcc}$ | - | - | $\pm 1$ | $\mu \mathrm{A}$ |
| Ioz | Off-State Current (Hi-Z) | OV $\leq$ Vout $\leq$ Vcc | - | - | $\pm 1$ | $\mu \mathrm{A}$ |
| Ron | Switch ON Resistance | $\mathrm{Vcc}=\mathrm{Min} ., \mathrm{VIN}=0 \mathrm{~V}$, ION $=30 \mathrm{~mA}$ | 20 | 28 | 40 | $\Omega$ |
| Ron | Switch ON Resistance | $\mathrm{Vcc}=$ Min., VIN $=2.4 \mathrm{~V}$, ION $=15 \mathrm{~mA}$ | 20 | 35 | 48 | $\Omega$ |
| VP | Pass Voltage ${ }^{(2)}$ | VIN $=\mathrm{Vcc}=5 \mathrm{~V}$, lout $=-5 \mu \mathrm{~A}$ | 3.7 | 4 | 4.2 | V |

NOTES:

1. Typical values are at $\mathrm{VcC}=5.0 \mathrm{~V}, \mathrm{TA}=25^{\circ} \mathrm{C}$.
2. Pass voltage is guaranteed but not production tested.

## TYPICAL ON RESISTANCE vs Vin AT Vcc = 5V



## POWER SUPPLY CHARACTERISTICS

| Symbol | Parameter | Test Conditions ${ }^{(1)}$ | Max. | Unit |
| :--- | :--- | :--- | :---: | :---: |
| IccQ | Quiescent Power Supply Current | Vcc $=$ Max., VIN $=$ GND or Vcc, $f=0$ | 3 | $\mu \mathrm{~A}$ |
| $\Delta \mathrm{ICC}$ | Power Supply Current per Control Input HIGH ${ }^{(2)}$ | Vcc $=$ Max., VIN $=3.4 \mathrm{~V}, \mathrm{f}=0$ | 1.5 | mA |
| ICCD | Dynamic Power Supply Current per MHz ${ }^{(3)}$ | Vcc $=$ Max., I and Y pins open <br> Control Inputs Toggling at $50 \%$ Duty Cycle | 0.25 | $\mathrm{~mA} / \mathrm{MHz}$ |

## NOTES:

1. For conditions shown as Min. or Max., use the appropriate values specified under DC Electrical Characteristics.
2. Per TLL driven input (VIN $=3.4 \mathrm{~V}$, control inputs only). I and Y pins do not contribute to $\Delta \mathrm{lcc}$.
3. This current applies to the control inputs only and represents the current required to switch internal capacitance at the specified frequency. The I and Y inputs generate no significant AC or DC currents as they transition. This parameter is guaranteed but not production tested.

## SWITCHING CHARACTERISTICS OVER OPERATING RANGE

$\mathrm{TA}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}, \mathrm{Vcc}=5.0 \mathrm{~V} \pm 5 \%$
CLOAD $=50 \mathrm{pF}$, RLOAD $=500 \Omega$ unless otherwise noted.

| Symbol | Parameter | Min. ${ }^{(1)}$ | Typ. | Max. |
| :---: | :--- | :---: | :---: | :---: |
| tPLH <br> tPHL | Data Propagation Delay ${ }^{(2,3)}$ <br> In to Y | - | - | $1.25{ }^{(3)}$ |
| tPZL <br> tPZH | Switch Turn-on Delay <br> Sn to Y | ns |  |  |
| tPZL <br> tPZH | Switch Turn-on Delay <br> EN to Y | 0.5 | - | 7 |
| tPLZ <br> tPHZ | Switch Turn-off Delay <br> (2) <br> EN to Y, Sn to Y | 0.5 | ns |  |

## NOTES:

1. Minimums are guaranteed but not production tested.
2. This parameter is guaranteed but not production tested.
3. The bus switch contributes no propagation delay other than the RC delay of the ON resistance of the switch and the load capacitance. The time constant for the switch alone is of the order of 1.25 ns for $\mathrm{CL}=50 \mathrm{pF}$. Since this time constant is much smaller than the rise and fall times of typical driving signals, it adds very little propagation delay to the system. Propagation delay of the bus switch, when used in a system, is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.

HIGH-SPEED CMOSQUICKSWITCHDUAL4:1 MUX/DEMUX

## ORDERING INFORMATION



Industrial $\left(-40^{\circ} \mathrm{C}\right.$ to $\left.+85^{\circ} \mathrm{C}\right)$

Quarter Size Outline Package (SO16-7) Small Outline IC (SO16-1)

High Speed CMOS Quickswitch Dual 4:1 Mux/Demux

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